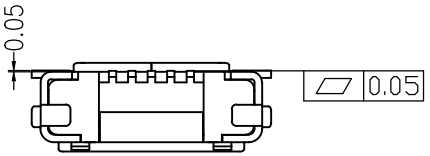
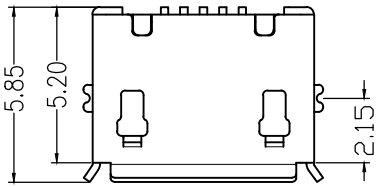
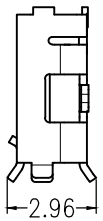
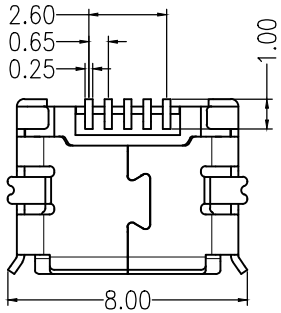
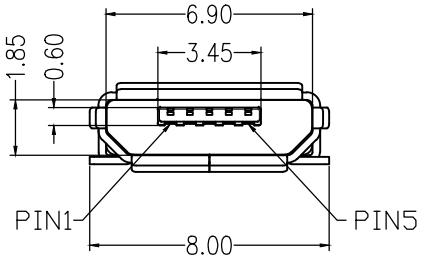
REV	DESCRIPTION	DATE	CHECK	APPROVAL
A0	NEW RELEASE	2024/01/19	MA	PENG

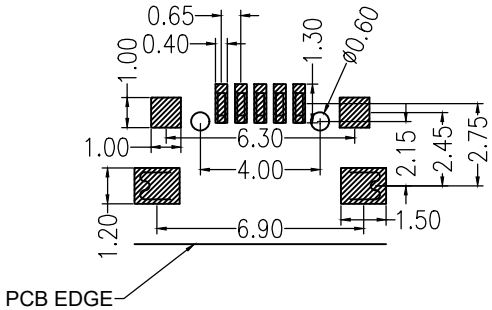




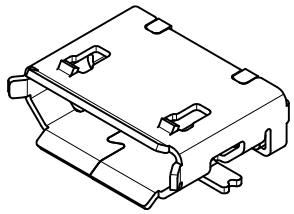








RECOMMENDED PCB LAYOUT
TOLERANCE:±0.05



NOTES:

1. MATERIAL:
   - 1.1 HOUSING:THERMOPLASTIC FLAMMABILITY RATING UL94-O
   - 1.2 CONTACT:COPPERY ALLOY T=0.20MM
   - 1.3 SHELL: COPPERY ALLOY T=0.25MM
2. FINISH:
   - 2.1 CONTACT:
     - 0.5U"MIN,PLATED ON CONTACT AREA
     - G/F PLATING ON SOLDER TAIL AREA
     - 40~50U" NICKEL UNDERPLATING OVERALL
   - 2.2 SHELL:
     - 50~60U" MATTER TIN PLAING ALL
     - 40~50U" NICKEL UNDERPLATING OVERALL
3. SPECIFICATION:
   - 3.3 CURRENT RATING:0.5A(2.3.4CONTACT)/1.8A (1.5CONTACT)MAX.
   - 3.2 VOLTAGE:30 VAC
   - 3.3 TEMPERATURE RANGE:-20°C~85°C
   - 3.4 CONTACT RESISTANCE:30 MILLIONHM MAX.
   - 3.5 DIELECTRIC WITHSTANDING VOLTAGE;250VAC R.M.S
   - 3.6 INSULATION RESISTNACE:100 MEGOHMS MIN

RoHS Compliant 2002/95/EC

GENERAL TOLERANCE		鸿康科技（东莞）有限公司 Hongkang Technology (Dongguan) Co., Ltd				PART NO.			
.X	0.30					TITLE. MICRO 5PIN 全贴板(卷口短端无柱)			
.XX	0.20	APPROVAL	CHECK	DRAWN	DATE				
.XXX	0.10					UNIT	SCALE	NUMBER	REV
PROJECT		PENG	MA	ZHANG	2024/01/19	MM	1 : 1	A- 00	A0